SiP32451, SiP32452, SiP32453





0.9 V to 2.5 V, 55 m Ω Load Switch in WCSP4

DESCRIPTION

SiP32451, SiP32452, and SiP32453 are n-channel integrated high side load switches that operate from 0.9 V to 2.5 V input voltage range.

SiP32451, SiP32452, and SiP32453 have low input logic control threshold that can interface with low voltage control GPIO directly without extra level shift or driver. There is a pull down at this EN logic control pin.

Turn on time is fast, less than 25 μ s typically for input voltage of 1.2 V or higher. SiP32451 and SiP32452 have fast turn off delay time of less than 1 μ s while SiP32453 features a guaranteed turn off delay of greater than 30 μ s, typically 90 μ s.

SiP32451 features an output discharge for fast turn off. SiP32451, SiP32452, and SiP32453 are available in compact wafer level CSP package, WCSP4 0.8 mm x 0.8 mm with 0.4 mm pitch.

FEATURES

- Low input voltage, 0.9 V to 2.5 V
- Low R_{ON}, 55 mΩ typical
- Fast turn on time
- · Low logic control with hysteresis
- · Reverse current blocking when disabled
- Integrated pull down at EN pin
- Output discharge (SiP32451)
- 4 bump WCSP 0.8 mm x 0.8 mm with 0.4 mm pitch package
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Battery operated devices
- Smart phones
- GPS and PMP
- Computer
- Medical and healthcare equipment
- · Industrial and instrument
- Cellular phones and portable media players
- Game console

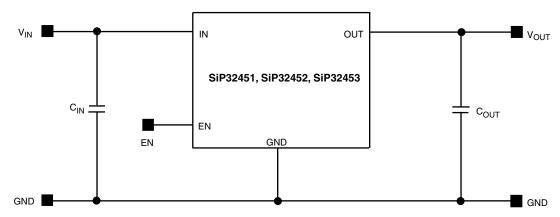


Fig. 1 - SiP32451, SiP32452, and SiP32453 Typical Application Circuit

| ORDERING INFORMATION | | | | | | | | |
|---|--|----------------------|-------------------|--|--|--|--|--|
| TEMPERATURE RANGE PACKAGE MARKING PART NUMBER | | | | | | | | |
| -40 °C to +85 °C | WCSP4: 4 bumps | AA | SiP32451DB-T2-GE1 | | | | | |
| | (2 x 2, 0.4 mm pitch, | AB SiP32452DB-T2-GE1 | SiP32452DB-T2-GE1 | | | | | |
| | 208 µm bump height, 0.8 mm x 0.8 mm die size) | AC | SiP32453DB-T2-GE1 | | | | | |

Note

· GE1 denotes halogen-free and RoHS-compliant

S20-0528-Rev. E, 06-Jul-2020 1 For technical questions, contact: now Document Number: 63315

HALOGEN FREE Available

TYPICAL APPLICATION CIRCUIT





| ABSOLUTE MAXIMUM RATINGS | | | | | | |
|--|---------------|------|--|--|--|--|
| PARAMETER | LIMIT | UNIT | | | | |
| Supply input voltage (VIN) | -0.3 to +2.75 | | | | | |
| Enable input voltage (V _{EN}) | -0.3 to +2.75 | V | | | | |
| Output voltage (V _{OUT}) | -0.3 to +2.75 | | | | | |
| Maximum continuous switch current (I _{max.}) | 1.2 | Α | | | | |
| Maximum pulsed current (I_{DM}) V_{IN} (pulsed at 1 ms, 10 % duty cycle) | 2 | A | | | | |
| ESD rating (HBM) | 4000 | V | | | | |
| Junction temperature (T _J) | -40 to +150 | °C | | | | |
| Thermal resistance $(\theta_{JA})^{a}$ | 280 | °C/W | | | | |
| Power dissipation (P _D) ^a | 196 | mW | | | | |

Notes

a. Device mounted with all leads and power pad soldered or welded to PC board

b. Derate 3.6 mW/°C above $T_A = 70$ °C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating/conditions for extended periods may affect device reliability.

| RECOMMENDED OPERATING RANGE | | | | | | |
|--|-------------|----|--|--|--|--|
| PARAMETER LIMIT UNIT | | | | | | |
| Input voltage range (V _{IN}) | 0.9 to 2.5 | V | | | | |
| Operating junction temperature range | -40 to +125 | °C | | | | |

| SPECIFICATIONS | | | | | | | |
|------------------------------------|----------------------|---|--------------------------------|-------------------|-------------------|-------------------|--------|
| | | TEST CONDITIONS UNLESS SPECIFIED | | LIMITS | | | |
| PARAMETER | SYMBOL | $V_{IN} = 1 \text{ V}, T_A = -40 \text{ °C to } +85 \text{ °C}$ (typical values are at $T_A = 25 \text{ °C}$) | | MIN. ^a | TYP. ^b | MAX. ^a | UNIT |
| Operating voltage ^c | V _{IN} | | | 0.9 | - | 2.5 | V |
| Quiescent current | 1- | $V_{IN} = 1.2 \text{ V}, V_{EN} = V_{IN}, \text{OUT} = \text{open}$ | | - | 10 | 15 | |
| | Ι _Q | V_{IN} = 2.5 V, V_{EN} | = V _{IN} , OUT = open | - | 34 | 60 | |
| Off supply current | 1 | SiP32451 | EN = GND, OUT = open | - | - | 30 | μA |
| | I _{Q(off)} | SiP32452, SiP32453 | LN = GND, OOT = Open | - | - | 1 | |
| Off switch current | I _{DS(off)} | EN = GNE | EN = GND, OUT = 0 V | | - | 30 | |
| Reverse blocking current | I _{RB} | $V_{OUT} = 2.5 \text{ V}, V_{IN} = 0.9 \text{ V}, V_{EN} = 0 \text{ V}$ | | - | 0.001 | 10 | |
| | R _{DS(on)} | V_{IN} = 1 V, I_L = 200 mA, T_A = 25 °C | | - | 56 | 65 | - mΩ |
| On-resistance | | V_{IN} = 1.2 V, I_L = 200 mA, T_A = 25 °C | | - | 55 | 65 | |
| On-resistance | | $V_{IN} = 1.8 \text{ V}, \text{ I}_{L} = 200 \text{ mA}, \text{ T}_{A} = 25 ^{\circ}\text{C}$ | | - | 54 | 65 | |
| | | $V_{IN} = 2.5 \text{ V}, I_L = 200 \text{ mA}, T_A = 25 \text{ °C}$ | | - | 54 | 65 | |
| On-resistance temp. coefficient | TC _{RDS} | | | - | 3900 | - | ppm/°C |
| Output pull-down resistance | R _{PD} | V _{EN} = 0 V, T _A = 25 °C (SiP32451 only) | | - | 425 | 550 | Ω |
| EN input low voltage ^c | VIL | V _{IN} = 1 V | | - | - | 0.1 | V |
| EN input high voltage ^c | V _{IH} | V _{IN} = 2.5 V | | 1.5 | - | - | V |
| EN input lookage | I _{EN} | V _{IN} = 2.5 V, V _{EN} = 0 V | | - | - | 1 | μΑ |
| EN input leakage | | V _{IN} = 2.5 V, V _{EN} = 2.5 V | | - | 10 | 15 | |



SPECIFICATIONS

| SPECIFICATIONS | | | | | | | |
|----------------------------|---------------------|--|---|-------------------|-------------------|-------------------|------|
| | | TEST CONDITIONS UNLESS SPECIFIED | | LIMITS | | | |
| PARAMETER | SYMBOL | $V_{IN} = 1 V$, $T_A = -40 \degree C$ to $+85 \degree C$ (typical values are at $T_A = 25 \degree C$) | | MIN. ^a | TYP. ^b | MAX. ^a | UNIT |
| Output turn on dolay time | + | V _{IN} = 1.2 V | | - | 0.4 | 1 | |
| Output turn-on delay time | t _{d(on)} | V _{IN} = 2.5 V | | - | 0.05 | 1 | |
| Output turn-on rise time | t _r | V _{IN} = 1.2 V | | 10 | 20 | 30 | |
| | | V _{IN} = 2.5 V | | 5 | 9.8 | 20 | |
| Output turn-off delay time | | SiP32451, SiP32452 V _{IN} = 1.2 V | $\label{eq:RLOAD} \begin{split} R_{LOAD} &= 10 \ \Omega, \\ C_{L} &= 0.1 \ \muF, \ T_{A} &= 25 \ ^{\circ}C \end{split}$ | - | 0.25 | 1 | μs |
| | t _{d(off)} | SiP32451, SiP32452 V _{IN} = 2.5 V | - | - | 0.15 | 1 | l |
| | | SiP32453, V _{IN} = 1.2 V | | 30 | 98 | 150 | |
| | | SiP32453, V _{IN} = 2.5 V | | 30 | 86 | 150 | |

Notes

a. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum

b. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing

c. For V_{IN} outside this range consult typical EN threshold curve

PIN CONFIGURATION

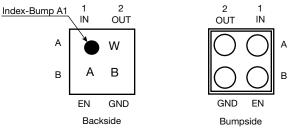


Fig. 2 - WCSP4 2 x 2 Package

| PIN DESCRIPTION | | | | | | |
|--------------------------|-----|--|--|--|--|--|
| PIN NUMBER NAME FUNCTION | | | | | | |
| A1 | IN | This pin is the n-channel MOSFET drain connection. Bypass to ground through a 4.7 µF capacitor | | | | |
| A2 | OUT | This pin is the n-channel MOSFET source connection. Bypass to ground through a 0.1 μ F capacitor | | | | |
| B1 | EN | Enable input | | | | |
| B2 | GND | Ground connection | | | | |



TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)

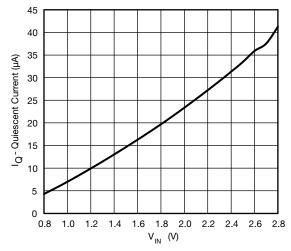


Fig. 3 - Quiescent Current vs. Input Voltage

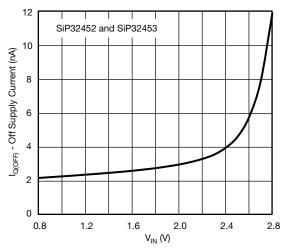
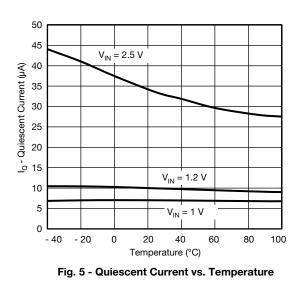


Fig. 4 - Off Supply Current vs. Input Voltage



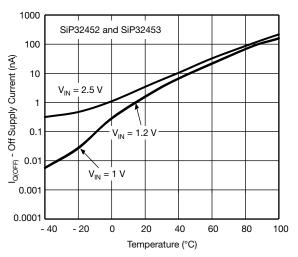
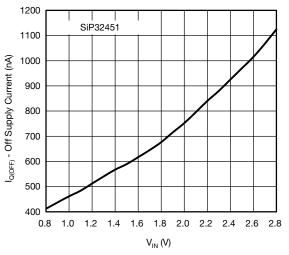
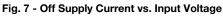


Fig. 6 - Off Supply Current vs. Temperature





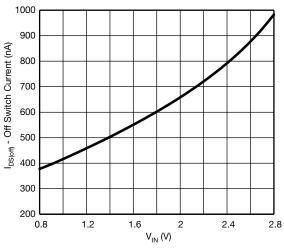


Fig. 8 - Off Switch Current vs. Input Voltage

S20-0528-Rev. E, 06-Jul-2020

4

Document Number: 63315

For technical questions, contact: <u>powerictechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)

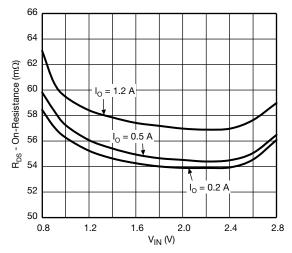
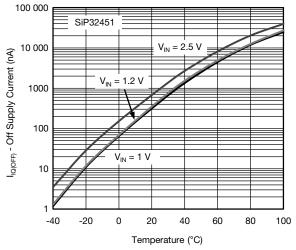
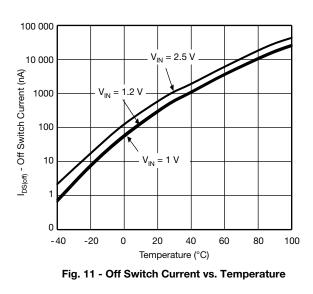


Fig. 9 - R_{DS(on)} vs. V_{IN}







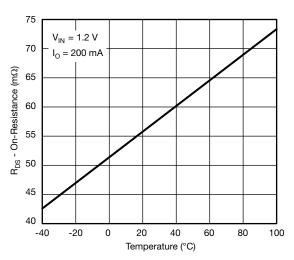
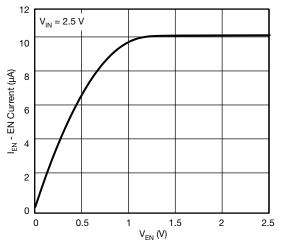
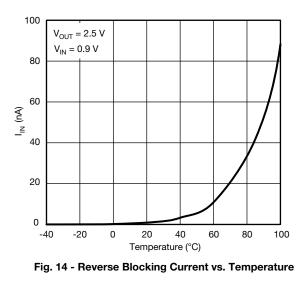


Fig. 12 - R_{DS(on)} vs. Temperature







S20-0528-Rev. E, 06-Jul-2020

5

Document Number: 63315

For technical questions, contact: <u>powerictechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>





TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)

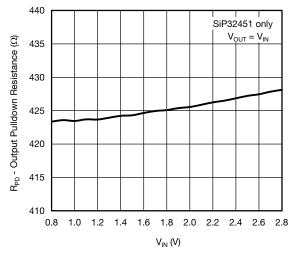


Fig. 15 - Output Pull-down Resistance vs. Input Voltage

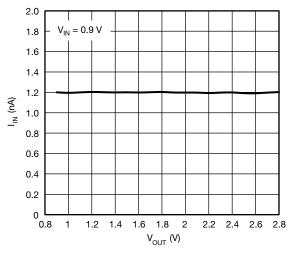


Fig. 16 - Reverse Blocking Current vs. Output Voltage

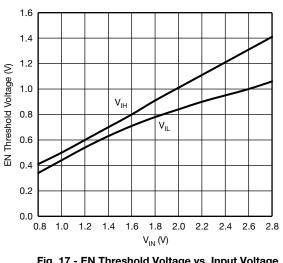


Fig. 17 - EN Threshold Voltage vs. Input Voltage

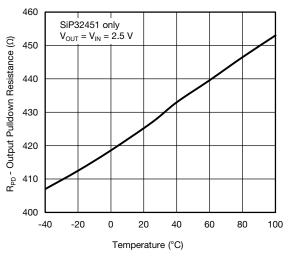


Fig. 18 - Output Pull-down Resistance vs. Temperature

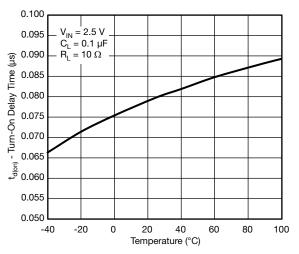


Fig. 19 - Turn-On Delay Time vs. Temperature

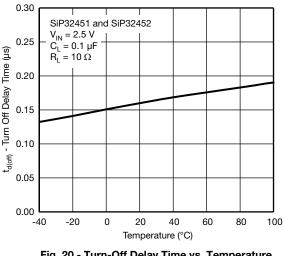


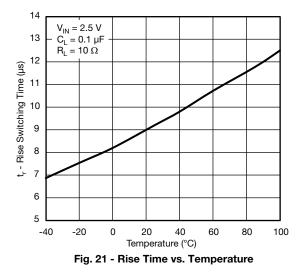
Fig. 20 - Turn-Off Delay Time vs. Temperature

Document Number: 63315

For technical questions, contact: powerictechsupport@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



TYPICAL CHARACTERISTICS (internally regulated, 25 °C, unless otherwise noted)



TYPICAL WAVEFORMS

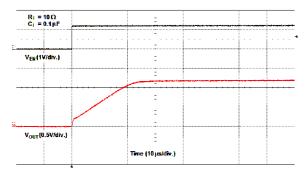
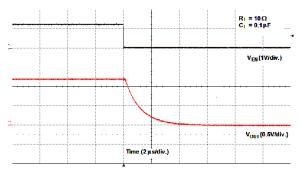
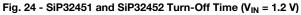


Fig. 23 - Turn-On Time (V_{IN} = 1.2 V)





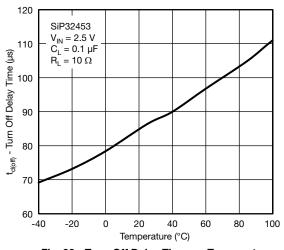
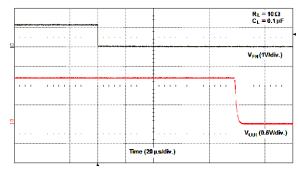
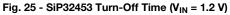


Fig. 22 - Turn-Off Delay Time vs. Temperature





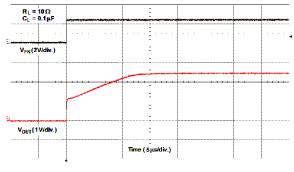


Fig. 26 - Turn-On Time (V_{IN} = 2.5 V)

SiP32451, SiP32452, SiP32453

Time (20 µs/div.)

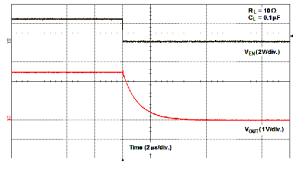
Fig. 28 - SiP32453 Turn-Off Time (V_{IN} = 2.5 V)

Vishay Siliconix

 $R_L = 10 \Omega$ $C_L = 0.1 \mu F$

VIN(2V/dlv.)

V_{OUT}(1V/div.)



www.vishay.com

Fig. 27 - SiP32451 and SiP32452 Turn-Off Time (V_{IN} = 2.5 V)

BLOCK DIAGRAM

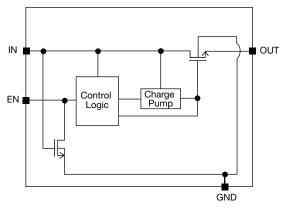


Fig. 29 - Functional Block Diagram

DETAILED DESCRIPTION

SiP32451, SiP32452, and SiP32453 are n-channel power MOSFET designed as high side load switch. Once enable the device charge pumps the gate of the power MOSFET to a constant gate to source voltage for fast turn on time. The mostly constant gate to source voltage keeps the on resistance low through out the input voltage range. When disable, the SiP32451 and SiP32452 pull the gate of the output n-channel low right away for a fast turn off delay while there is a build-in turn off delay for the SiP32453. The SiP32451 especially features a output discharge circuit to help discharge the output capacitor. The turn off delay for the SiP32453 is guaranteed to be at least 30 µs. Because the body of the output n-channel is always connected to GND, it prevents the current from going back to the input in case the output voltage is higher than the output.

APPLICATION INFORMATION

Input Capacitor

While a bypass capacitor on the input is not required, a 4.7 μ F or larger capacitor for C_{IN} is recommended in almost all applications. The bypass capacitor should be placed as physically close as possible to the input pin to be effective in minimizing transients on the input. Ceramic capacitors are recommended over tantalum because of

their ability to withstand input current surges from low impedance sources such as batteries in portable devices.

Output Capacitor

A 0.1 μ F capacitor across V_{OUT} and GND is recommended to insure proper slew operation. There is inrush current through the output MOSFET and the magnitude of the inrush current depends on the output capacitor, the bigger the C_{OUT} the higher the inrush current. There are no ESR or capacitor type requirement.

Enable

The EN pin is compatible with CMOS logic voltage levels. It requires at least 0.1 V or below to fully shut down the device and 1.5 V or above to fully turn on the device.

Protection Against Reverse Voltage Condition

SiP32451, SiP32452, and SiP32453 can block the output current from going to the input in case where the output voltage is higher than the input voltage when the main switch is off.

Thermal Considerations

These devices are designed to maintain a constant output load current. Due to physical limitations of the layout and assembly of the device the maximum switch current is 1.2 A as stated in the Absolute Maximum Ratings table. However,

For technical questions, contact: <u>powerictechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>





another limiting characteristic for the safe operating load current is the thermal power dissipation of the package. To obtain the highest power dissipation (and a thermal resistance of 280 °C/W) the device should be connected to a heat sink on the printed circuit board.

The maximum power dissipation in any application is dependent on the maximum junction temperature, T_J (max.) = 125 °C, the junction-to-ambient thermal resistance, $\theta_{J-A} = 280$ °C/W, and the ambient temperature, T_A , which may be formulaically expressed as:

P (max.) =
$$\frac{T_{J(max.)} - T_A}{\theta_{JA}} = \frac{125 - T_A}{280}$$

It then follows that, assuming an ambient temperature of 70 °C, the maximum power dissipation will be limited to about 196 mW.

So long as the load current is below the 1.2 A limit, the maximum continuous switch current becomes a function two things: the package power dissipation and the $R_{DS(on)}$ at the ambient temperature.

As an example let us calculate the worst case maximum load current at $T_A = 70$ °C. The worst case $R_{DS(on)}$ at 25 °C is

Vishay Siliconix

65 m $\Omega.$ The R_{DS(on)} at 70 $^\circ\text{C}$ can be extrapolated from this data using the following formula:

 $R_{DS(on)}$ (at 70 °C) = $R_{DS(on)}$ (at 25 °C) x (1 + $T_C x \Delta T$)

Where T_C is 3900 ppm/°C. Continuing with the calculation we have

 ${\sf R}_{{\sf DS}({\sf on})}$ (at 70 °C) = 65 m Ω x (1 + 0.0039 x (70 °C - 25 °C)) = 76.4 m Ω

The maximum current limit is then determined by

$$I_{LOAD(max.)} < \sqrt{\frac{P(max.)}{R_{DS(on)}}}$$

which in this case is 1.6 A. Under the stated input voltage condition, if the 1.6 A current limit is exceeded the internal die temperature will rise and eventually, possibly damage the device.

To avoid possible permanent damage to the device and keep a reasonable design margin, it is recommended to operate the device maximum up to 1.2 A only as listed in the Absolute Maximum Ratings table.



www.vishay.com

SiP32451, SiP32452, SiP32453

Vishay Siliconix

| PRODUCT SUMMARY | | | | |
|---|---|--|--|--|
| Part number | SiP32451 | SiP32452 | SiP32453 | |
| Description | 0.9 V to 2.5 V, 55 mΩ, bidirectional off isolation, fast turn on / off, output discharge | 0.9 V to 2.5 V, 55 mΩ, bidirectional off isolation, fast turn on / off | 0.9 V to 2.5 V, 55 mΩ, bidirectional off isolation fast turn on and 98 µs tur off delay | |
| Configuration | Single | Single | Single | |
| Slew rate time (µs) | 20 | 20 | 20 | |
| On delay time (µs) | 0.4 | 0.4 | 0.4 | |
| Input voltage min. (V) | 0.9 | 0.9 | 0.9 | |
| Input voltage max. (V) | 2.5 | 2.5 | 2.5 | |
| On-resistance at input voltage min. (mΩ) | 56 | 56 | 56 | |
| On-resistance at input voltage max. (m Ω) | 54 | 54 | 54 | |
| Quiescent current at input voltage min. (µA) | 4 | 4 | 4 | |
| Quiescent current at input voltage max. (µA) | 32 | 32 | 32 | |
| Output discharge (yes / no) | Yes | No | No | |
| Reverse blocking (yes / no) | Yes | Yes | Yes | |
| Continuous current (A) | 1.2 | 1.2 | 1.2 | |
| Package type | WCSP4 | WCSP4 | WCSP4 | |
| Package size (W, L, H) (mm) | 0.8 x 0.8 x 0.5 | 0.8 x 0.8 x 0.5 | 0.8 x 0.8 x 0.5 | |
| Status code | 2 | 2 | 2 | |
| Product type | Slew rate | Slew rate | Slew rate | |
| Applications | Computers, consumer, industrial, healthcare, networking, portable | Computers, consumer, industrial, healthcare, networking, portable | Computers, consumer, industrial, healthcare, networking, portable | |

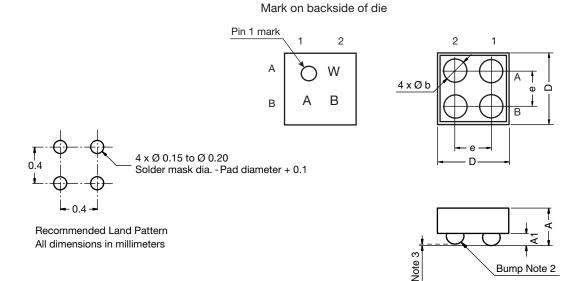
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?63315</u>

10



WCSP4: 4 Bumps

(2 x 2, 0.4 mm pitch, 208 µm bump height, 0.8 mm x 0.8 mm die size)



DWG-No: 6004

Notes

⁽¹⁾ Laser mark on the backside surface of die

(2) Bumps are SAC396

⁽³⁾ 0.05 max. coplanarity

| DIM. | MILLIMETERS ^a | | | INCHES | | |
|------|--------------------------|-------|-------|-----------------|--------|--------|
| DIM. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. |
| A | 0.515 | 0.530 | 0.545 | 0.0203 | 0.0209 | 0.0215 |
| A1 | 0.208 | | | 0.0082 | | |
| b | 0.250 0.260 | | 0.270 | 0.0098 0.0102 0 | | 0.0106 |
| e | 0.400 | | | | 0.0157 | |
| D | 0.720 | 0.760 | 0.800 | 0.0283 | 0.0299 | 0.0315 |

Note

a. Use millimeters as the primary measurement



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.